

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	576	(hydrogen H2 "H.sub.2") with (nitrogen N2 "N.sub.2") with (fluorine F2 "F.sub.2") same (plasma etch\$3)	US-PGPU B; USPAT	OR	ON	2005/09/16 21:33
L2	406	(hydrogen H2 "H.sub.2") with (nitrogen N2 "N.sub.2") with (fluorine F2 "F.sub.2") with (plasma etch\$3)	US-PGPU B; USPAT	OR	ON	2005/09/16 20:39
L3	294	(hydrogen H2 "H.sub.2") with (nitrogen N2 "N.sub.2") with (fluorine F2 "F.sub.2") with (plasma)	US-PGPU B; USPAT	OR	ON	2005/09/16 20:39
L4	207	(hydrogen H2 "H.sub.2") with (nitrogen N2 "N.sub.2") with (fluorine F2 "F.sub.2") with (etch\$3)	US-PGPU B; USPAT	OR	ON	2005/09/16 20:40
L5	95	3 and 4	US-PGPU B; USPAT	OR	ON	2005/09/16 20:40
L6	193	1 and (hybrid composite \$2organic/\$2organic \$2organic-\$2organic organic near2 inorganic)	US-PGPU B; USPAT	OR	ON	2005/09/16 20:56
L7	14	1 same (hybrid composite \$2organic/\$2organic \$2organic-\$2organic organic near2 inorganic)	US-PGPU B; USPAT	OR	ON	2005/09/16 20:59
L8	103839	1 (interlayer intermediate near layer IDL)	US-PGPU B; USPAT	OR	ON	2005/09/16 21:00
L9	124	1 and (interlayer intermediate near layer IDL)	US-PGPU B; USPAT	OR	ON	2005/09/16 21:00
L10	10	1 same (interlayer intermediate near layer IDL)	US-PGPU B; USPAT	OR	ON	2005/09/16 21:00

L11	0	("2004/0084413").URPN.	USPAT	OR	OFF	2005/09/16 21:01
L12	101	(hydrogen H2 "H.sub.2") with (nitrogen N2 "N.sub. 2") with (fluorine F2 "F. sub.2") same (plasma etch\$3)	EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/09/16 21:27
L13	78	(hydrogen H2 "H.sub.2") with (nitrogen N2 "N.sub. 2") with (fluorine F2 "F. sub.2") WITH (plasma etch\$3)	EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/09/16 21:28
L14	3	13 same (interlayer intermediate near layer IDL)	EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/09/16 21:06
L15	1	(hydrogen H2 "H.sub.2") with (nitrogen N2 "N.sub. 2") with (fluorine F2 "F. sub.2") WITH (plasma etch\$3) AND (hybrid composite \$2organic/\$2organic \$2organic-\$2organic organic near2 inorganic)	EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/09/16 21:24
L16	13	(hydrogen H2 "H.sub.2") AND (nitrogen N2 "N.sub. 2") AND (fluorine F2 "F. sub.2") AND (plasma etch\$3) AND (hybrid composite \$2organic/\$2organic \$2organic-\$2organic organic near2 inorganic interlayer intermediate near layer IDL)	EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/09/16 21:25
L17	238	(hydrogen H2 "H.sub.2") AND (nitrogen N2 "N.sub. 2") AND (fluorine F2 "F. sub.2") AND (plasma etch\$3)	EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/09/16 21:29

L18	9	(hydrogen H2 "H.sub.2") AND (nitrogen N2 "N.sub.2") AND (fluorine F2 "F.sub.2") AND (plasma etch\$3) AND (interlayer intermediate near layer IDL)	EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2005/09/16 21:29
L20	0	("US6177364B").PN.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/16 21:31
L21	2	("6177364").PN.	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/16 21:31
L22	19	("5920790" "5989998" "5994778").PN. OR ("6177364").URPN.	US-PGPU B; USPAT; USOCR	OR	OFF	2005/09/16 21:32
L23	51570	22 OR (hydrogen H2 "H.sub.2" nitrogen N2 "N.sub.2" fluorine F2 "F.sub.2") WITH (PLASMA ETCH\$3)	US-PGPU B; USPAT	OR	ON	2005/09/16 21:34
L24	15	22 AND (hydrogen H2 "H.sub.2" nitrogen N2 "N.sub.2" fluorine F2 "F.sub.2") WITH (PLASMA ETCH\$3)	US-PGPU B; USPAT	OR	ON	2005/09/16 21:37
L25	15	22 AND (hydrogen H2 "H.sub.2" nitrogen N2 "N.sub.2" fluorine F2 "F.sub.2") SAME (PLASMA ETCH\$3)	US-PGPU B; USPAT	OR	ON	2005/09/16 21:35

L26	16	22 AND (hydrogen H2 "H. sub.2" nitrogen N2 "N. sub.2" fluorine F2 "F.sub. 2") AND (PLASMA ETCH\$3)	US-PGPU B; USPAT	OR	ON	2005/09/16 21:35
L27	16	22 AND (hydrogen H2 "H. sub.2" nitrogen N2 "N. sub.2" fluorine F2 "F.sub. 2")	US-PGPU B; USPAT	OR	ON	2005/09/16 21:35
L28	3	22 NOT 27	US-PGPU B; USPAT	OR	ON	2005/09/16 21:36
L29	1	27 NOT 25	US-PGPU B; USPAT	OR	ON	2005/09/16 21:36